Switching (60V, 200mA)

SM6K2

Features

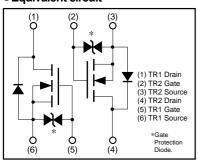
- 1) Two RHU002N06 chips in a SMT package.
- 2) Mounting possible with SMT3 automatic mounting
- 3) Transistor elements are independent, eliminating interference.
- 4) Mounting cost and area can be cut in half.

Structure

Silicon N-channel MOSFET transistor

The following characteristics apply to both Tr1 and Tr2.

Equivalent circuit

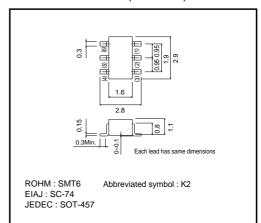


A protection diode has been built in between the gate and the source to protect against static electricity when the product is in use.

● Absolute maximum ratings (Ta=25°C)

| Parameter | - | Symbol | Limits | Unit |
|------------------------|------------|-------------|-------------|------|
| Drain-source voltage | | Voss | 60 | V |
| Gate-source voltage | | Vgss | ±20 | V |
| | Continuous | lσ | 200 | mA |
| Drain current | Pulsed | I IDP*1 800 | mA | |
| Drain reverse current | Continuous | Idr | 200 | mA |
| | Pulsed | IDRP*1 | 800 | mA |
| Total power dissipatio | n | Pp*2 200 m | | mW |
| Channel temperature | | Tch | 150 | °C |
| Storage temperature | | Tstg | −55~+150 °C | |

●External dimensions (Units : mm)



^{*1} Pw≤10μs, Duty cycle≤1% *2 When using 1×0.75×0.062 inch glass epoxy board.

● Electrical characteristics (Ta=25°C)

| Parameter | Symbol | Min. | Тур. | Max. | Unit | Test Conditions | |
|----------------------------------|--------------------|------|------|------|------|---|--|
| Gate leakage current | Igss | - | _ | ±10 | μΑ | Vgs=±20V, Vps=0V | |
| Drain-source breakdown voltage | V (BR) DSS | 60 | _ | _ | V | I _D =10μA, V _G s=0V | |
| Drain cutoff current | Ipss | _ | _ | 1 | μΑ | V _{DS} =60V, V _{GS} =0V | |
| Gate threshold voltage | VGS (th) | 1 | _ | 2.5 | V | V _{DS} =10V, I _D =1mA | |
| Drain-source on-state resistance | RDS (on)*1 | _ | 1.7 | 2.4 | Ω | ID=200mA, Vgs=10V | |
| | | _ | 2.8 | 4.0 | | ID=200mA, VGS=4V | |
| Forward transfer admittance | I Yfs I*1 | 100 | _ | _ | mS | V _{DS} =10V, I _D =200mA | |
| Input capacitance | Ciss | _ | 15 | - | pF | V _{DS} =25V V _{GS} =0V f=1MHz | |
| Output capacitance | Coss | _ | 8 | _ | pF | | |
| Reverse transfer capacitance | Crss | _ | 4 | - | pF | | |
| Turn-on delay time | td (on)*2 | _ | 6 | _ | ns | I _D =100mA, V _{DD} =30V V _{GS} =10V R _L =300Ω R _{GS} =10Ω | |
| Rise time | tr*2 | _ | 5 | - | ns | | |
| Turn-off delay time | td (off)*2 | _ | 12 | _ | ns | | |
| Fall time | t _f *2 | _ | 95 | _ | ns | | |
| Total gate charge | Qg*2 | _ | 2.2 | 4.4 | nC | V _{DD} ≒30V V _{GS} =10V I _D =200mA | |
| Gate-source charge | Q _{gs} *2 | _ | 0.6 | _ | nC | | |
| Gate-drain charge | Q _{gd} *2 | - | 0.3 | - | nC | | |

^{*1} Pw≤300μs, Duty cycle≤1% *2 Pulsed

Packaging specifications

| | Package | Taping |
|-------|------------------------------|--------|
| | Code | T110 |
| Туре | Basic ordering unit (pieces) | 3000 |
| SM6K2 | | 0 |

• Electrical characteristic curves

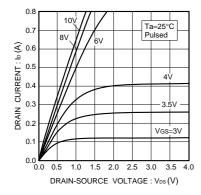


Fig.1 Typical output characteristics

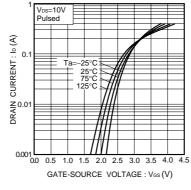


Fig.2 Typical transfer characteristics

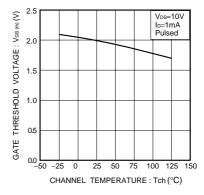


Fig.3 Gate threshold voltage vs. channel temperature



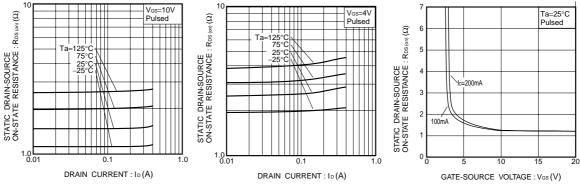


Fig.4 Static drain-source on-State resistance vs. drain current (I)

Fig.5 Static drain-source on-state resistance vs. drain current (II)

Fig.6 Static drain-source on-state resistance vs. gate-source voltage

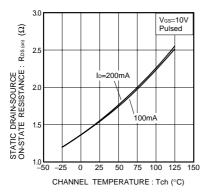


Fig.7 Static drain-source on-state resistance vs. channel temperature

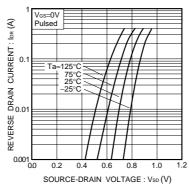


Fig.8 Reverse drain current vs. source-drain voltage (I)

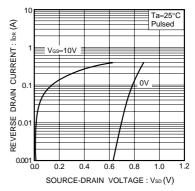


Fig.9 Reverse drain current vs. source-drain voltage (II)

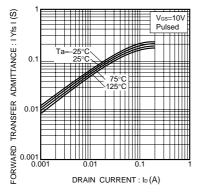


Fig.10 Forward transfer admittance vs. drain current

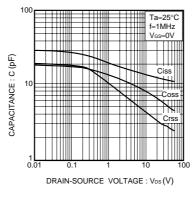


Fig.11 Typical capacitance vs. drain-source voltage

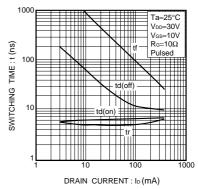


Fig.12 Switching characteristics

•Switching characteristics measurement circuit

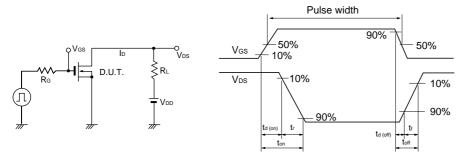


Fig.13 Switching time test circuit

Fig.14 Switching time waveforms

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